

N-Channel Reduced Q_g , Fast Switching MOSFET

| PRODUCT SUMMARY | | | |
|-----------------|----------------------------|-----------|--------------|
| V_{DS} (V) | $R_{DS(on)}$ (Ω) | I_D (A) | Q_g (Typ.) |
| 30 | 0.007 at $V_{GS} = 10$ V | 16 | 11 |
| | 0.0095 at $V_{GS} = 4.5$ V | 13.5 | |

FEATURES

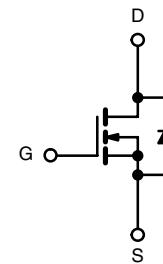
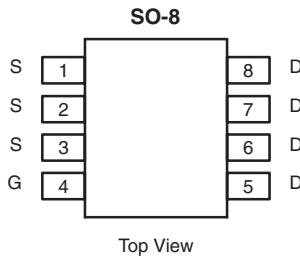
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Gen II Power MOSFETs
- PWM Optimized
- 100 % R_g Tested



RoHS
COMPLIANT
HALOGEN
FREE
Available

APPLICATIONS

- DC/DC Conversion for PC



Ordering Information: Si4386DY-T1-E3 (Lead (Pb)-free)
Si4386DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted | | | | | | |
|--|---------------|----------------|------------|--------------|------|--|
| Parameter | | Symbol | 10 s | Steady State | Unit | |
| Drain-Source Voltage | | V_{DS} | 30 | | V | |
| Gate-Source Voltage | | V_{GS} | ± 20 | | | |
| Continuous Drain Current ($T_J = 150$ °C) ^a | $T_A = 25$ °C | I_D | 16 | 11 | A | |
| | $T_A = 70$ °C | | 13 | 9 | | |
| Pulsed Drain Current | | I_{DM} | ± 50 | | | |
| Continuous Source Current (Diode Conduction) ^a | | I_S | 2.8 | 1.3 | | |
| Single Pulse Avalanche Current | $L = 0.1$ mH | I_{AS} | 20 | | mJ | |
| Avalanche Energy | | E_{AS} | 20 | | | |
| Maximum Power Dissipation ^a | $T_A = 25$ °C | P_D | 3.1 | 1.47 | W | |
| | $T_A = 70$ °C | | 2 | 0.95 | | |
| Operating Junction and Storage Temperature Range | | T_J, T_{stg} | -55 to 150 | | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|---------------|------------|---------|------|------|
| Parameter | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient (MOSFET) ^a | $t \leq 10$ s | R_{thJA} | 34 | 40 | °C/W |
| | Steady State | | 71 | 85 | |
| Maximum Junction-to-Foot (Drain) | Steady State | R_{thJF} | 18 | 22 | |

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

MOSFET SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted

| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---------------------|---|------|--------|-----------|---------------|
| Static | | | | | | |
| Gate Threshold Voltage | $V_{GS(\text{th})}$ | $V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$ | 1.5 | 2.0 | 2.5 | V |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0 \text{ V}$, $V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 30 \text{ V}$, $V_{GS} = 0 \text{ V}$ | | 1 | | μA |
| | | $V_{DS} = 30 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_J = 70^\circ\text{C}$ | | 10 | | |
| On-State Drain Current ^a | $I_{D(\text{on})}$ | $V_{DS} \geq 5 \text{ V}$, $V_{GS} = 10 \text{ V}$ | 40 | | | A |
| Drain-Source On-State Resistance ^a | $R_{DS(\text{on})}$ | $V_{GS} = 10 \text{ V}$, $I_D = 16 \text{ A}$ | | 0.0058 | 0.007 | Ω |
| | | $V_{GS} = 4.5 \text{ V}$, $I_D = 13.5 \text{ A}$ | | 0.0078 | 0.0095 | |
| Forward Transconductance ^a | g_{fs} | $V_{DS} = 15 \text{ V}$, $I_D = 16 \text{ A}$ | | 51 | | S |
| Diode Forward Voltage ^a | V_{SD} | $I_S = 2.8 \text{ A}$, $V_{GS} = 0 \text{ V}$ | | 0.75 | 1.1 | V |
| Dynamic^b | | | | | | |
| Total Gate Charge | Q_g | $V_{DS} = 15 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 16 \text{ A}$ | | 11 | 18 | nC |
| Gate-Source Charge | Q_{gs} | | | 5.8 | | |
| Gate-Drain Charge | Q_{gd} | | | 3.0 | | |
| Gate Resistance | R_g | | 0.8 | 1.7 | 2.5 | Ω |
| Turn-On Delay Time | $t_{d(\text{on})}$ | $V_{DD} = 15 \text{ V}$, $R_L = 15 \Omega$ $I_D \geq 1 \text{ A}$, $V_{GEN} = 10 \text{ V}$, $R_g = 6 \Omega$ | | 12 | 18 | ns |
| Rise Time | t_r | | | 9 | 14 | |
| Turn-Off Delay Time | $t_{d(\text{off})}$ | | | 35 | 53 | |
| Fall Time | t_f | | | 10 | 15 | |
| Source-Drain Reverse Recovery Time | t_{rr} | $I_F = 2.8 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$ | | 25 | 50 | |

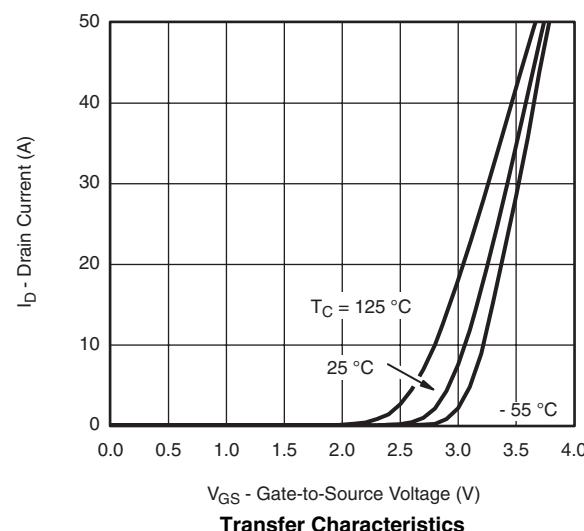
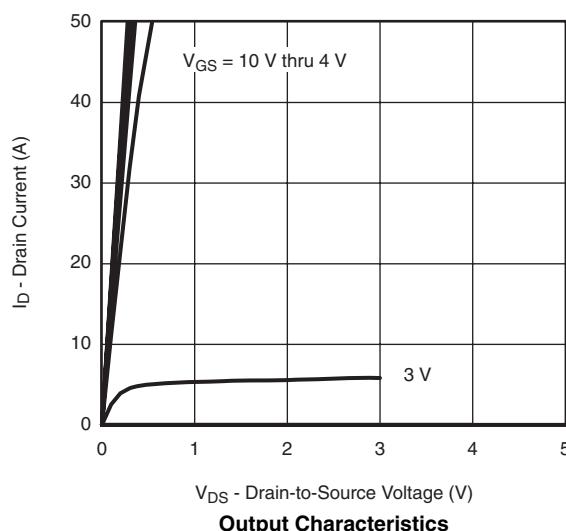
Notes:

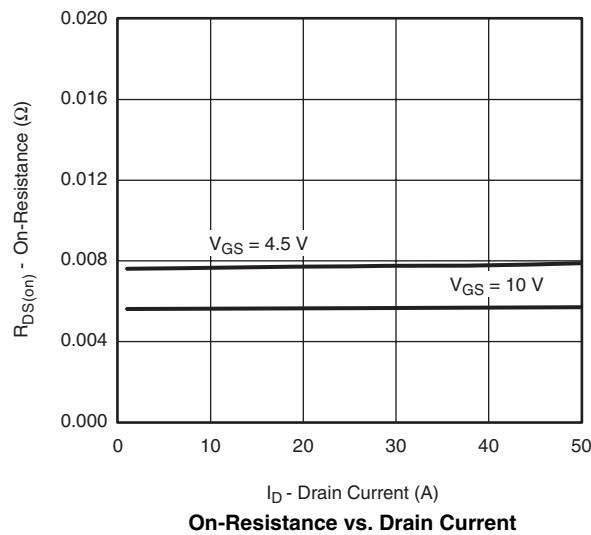
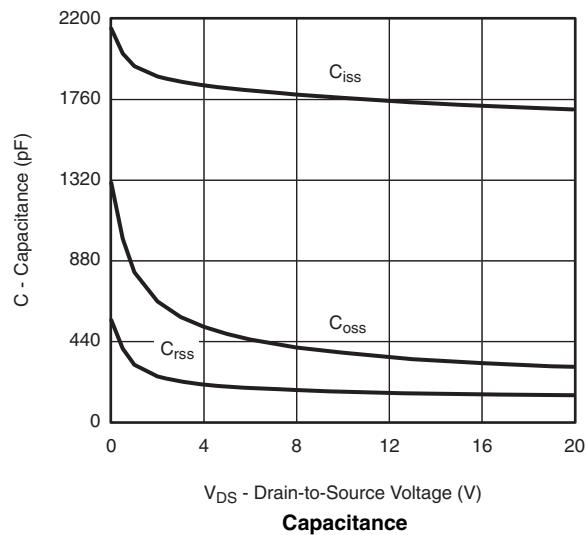
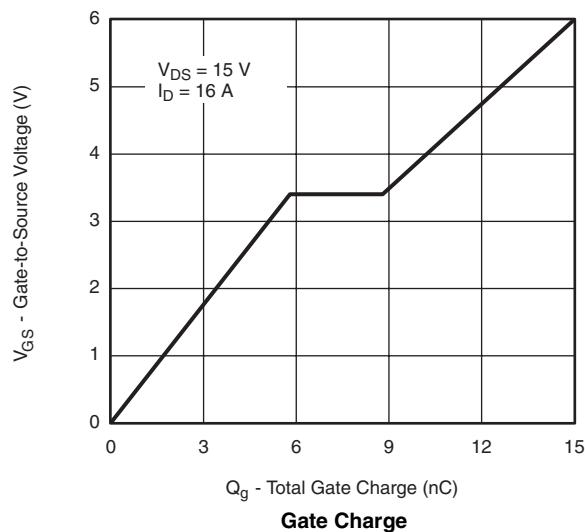
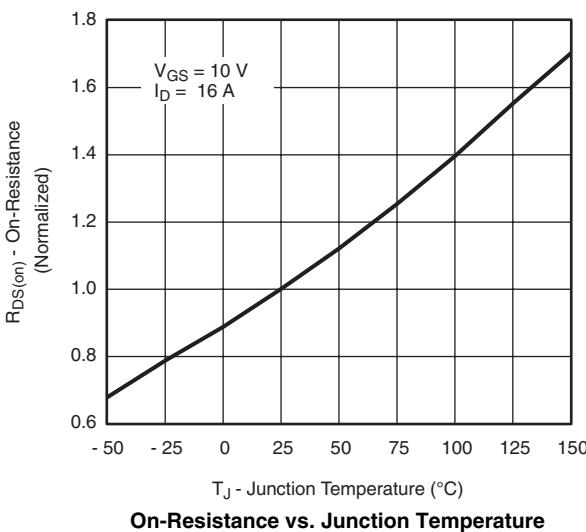
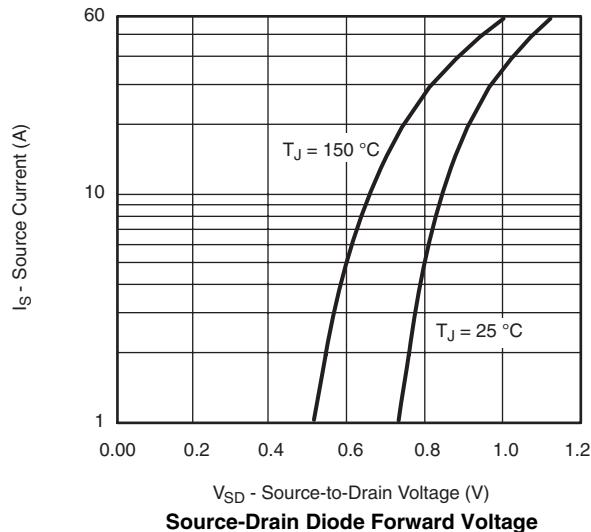
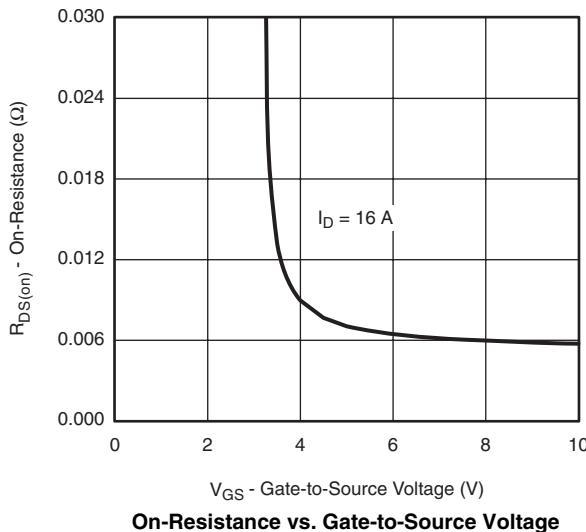
a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

b. Guaranteed by design, not subject to production testing.

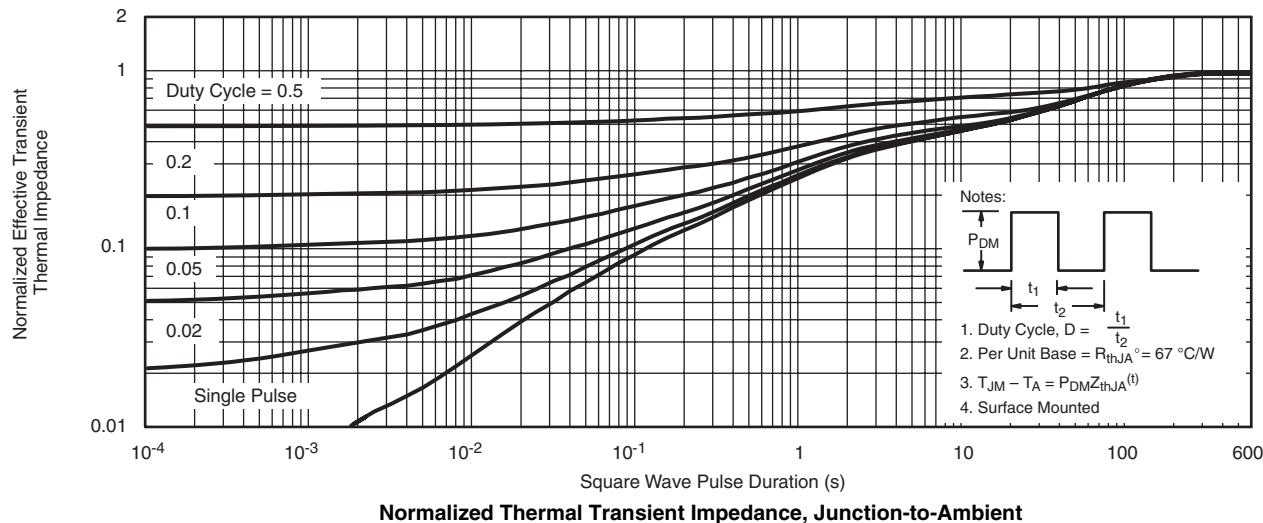
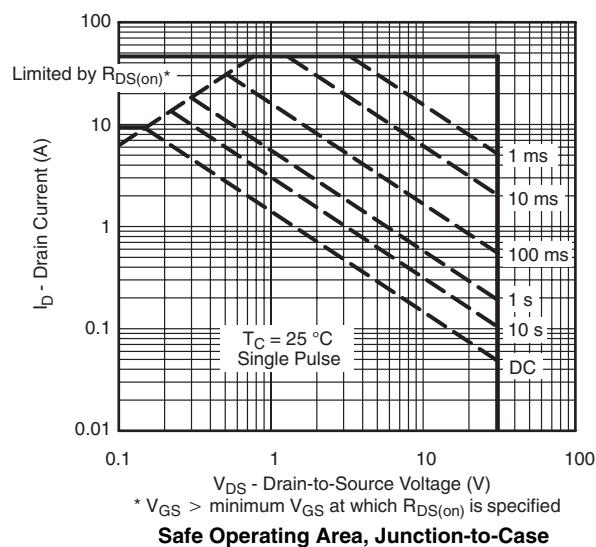
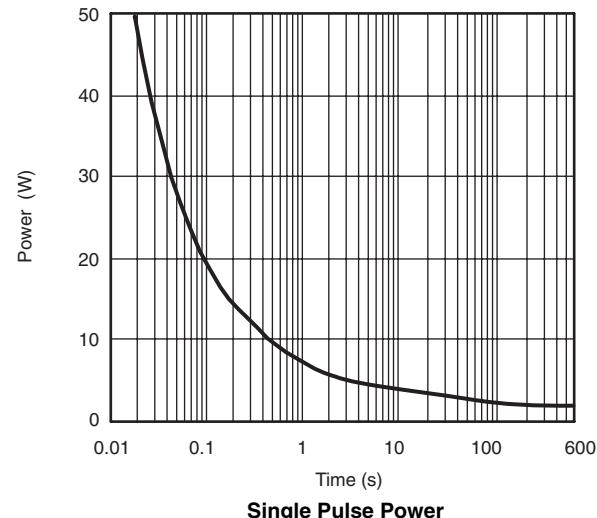
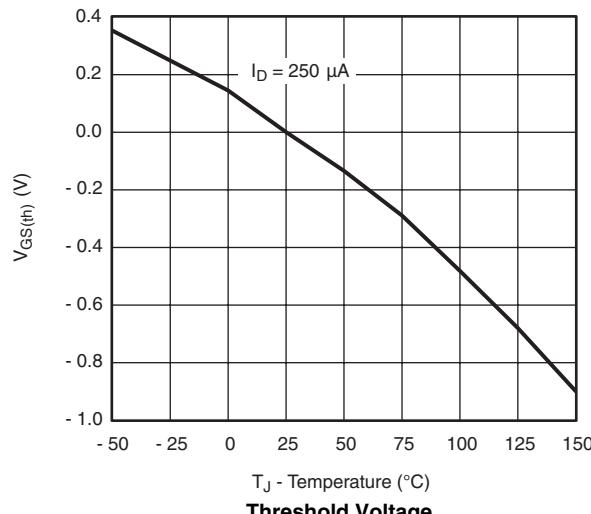
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

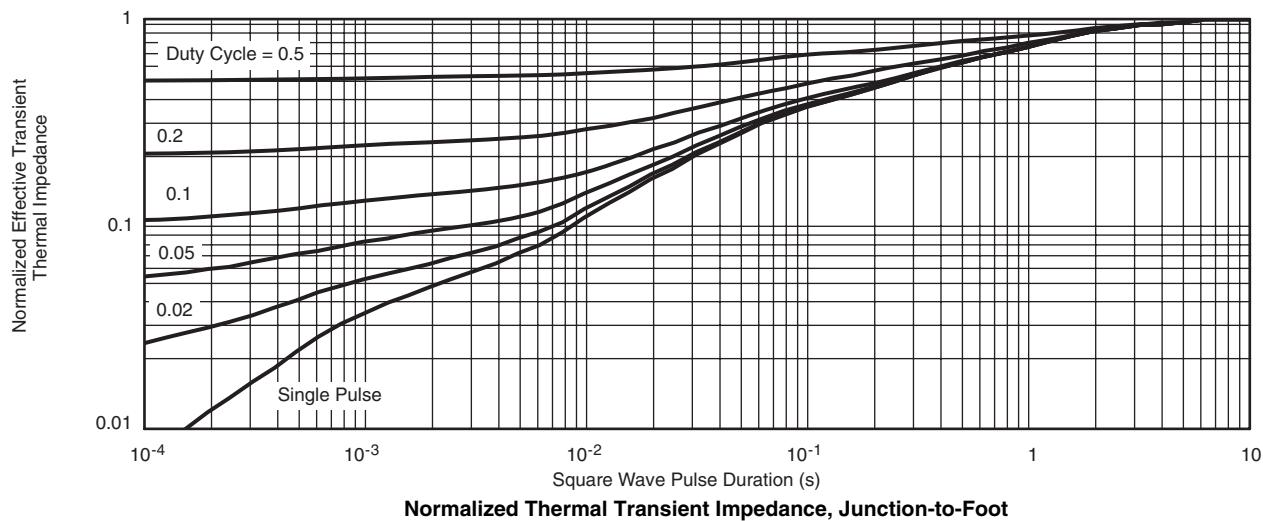
TYPICAL CHARACTERISTICS 25°C , unless otherwise noted



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

On-Resistance vs. Drain Current

Capacitance

Gate Charge

On-Resistance vs. Junction Temperature

Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

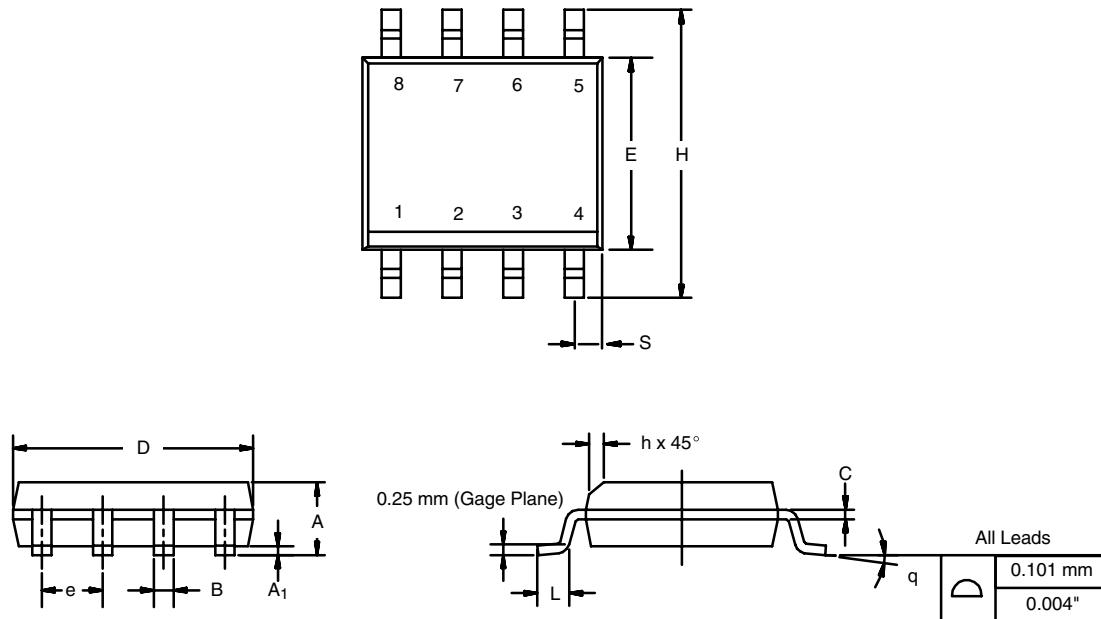


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted


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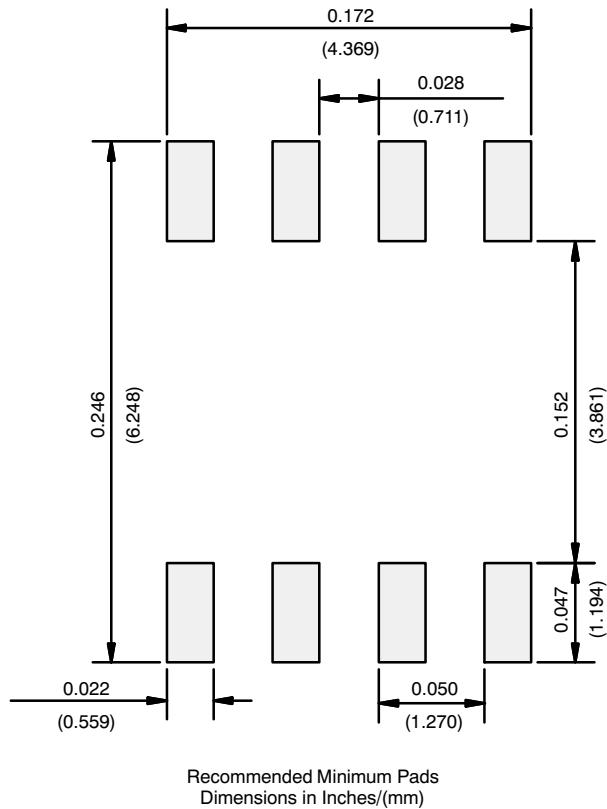
SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012



| DIM | MILLIMETERS | | INCHES | |
|--------------------------------|-------------|------|-----------|-------|
| | Min | Max | Min | Max |
| A | 1.35 | 1.75 | 0.053 | 0.069 |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 |
| B | 0.35 | 0.51 | 0.014 | 0.020 |
| C | 0.19 | 0.25 | 0.0075 | 0.010 |
| D | 4.80 | 5.00 | 0.189 | 0.196 |
| E | 3.80 | 4.00 | 0.150 | 0.157 |
| e | 1.27 BSC | | 0.050 BSC | |
| H | 5.80 | 6.20 | 0.228 | 0.244 |
| h | 0.25 | 0.50 | 0.010 | 0.020 |
| L | 0.50 | 0.93 | 0.020 | 0.037 |
| q | 0° | 8° | 0° | 8° |
| S | 0.44 | 0.64 | 0.018 | 0.026 |
| ECN: C-06527-Rev. I, 11-Sep-06 | | | | |
| DWG: 5498 | | | | |

RECOMMENDED MINIMUM PADS FOR SO-8



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